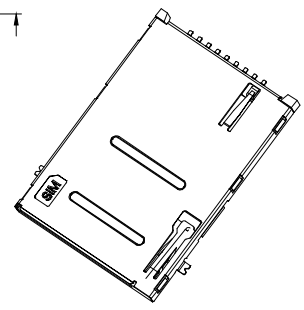
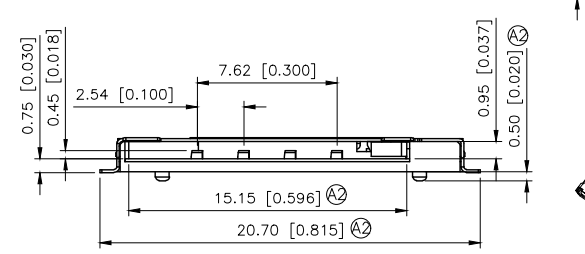
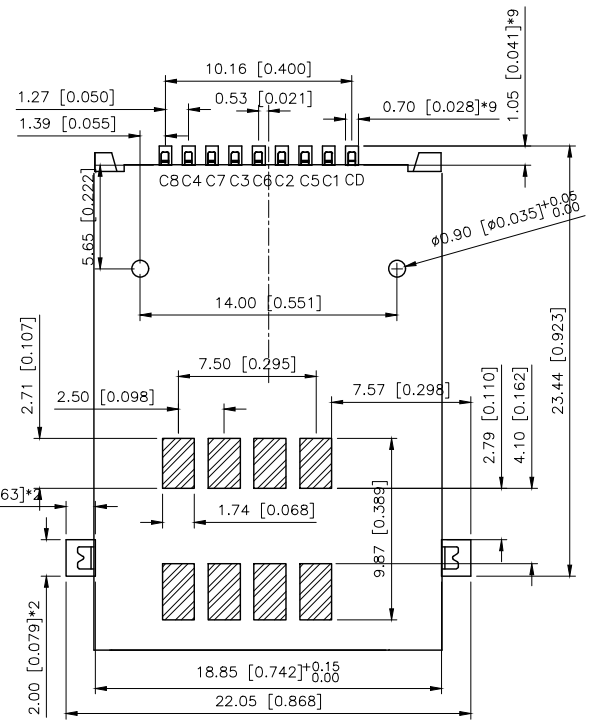
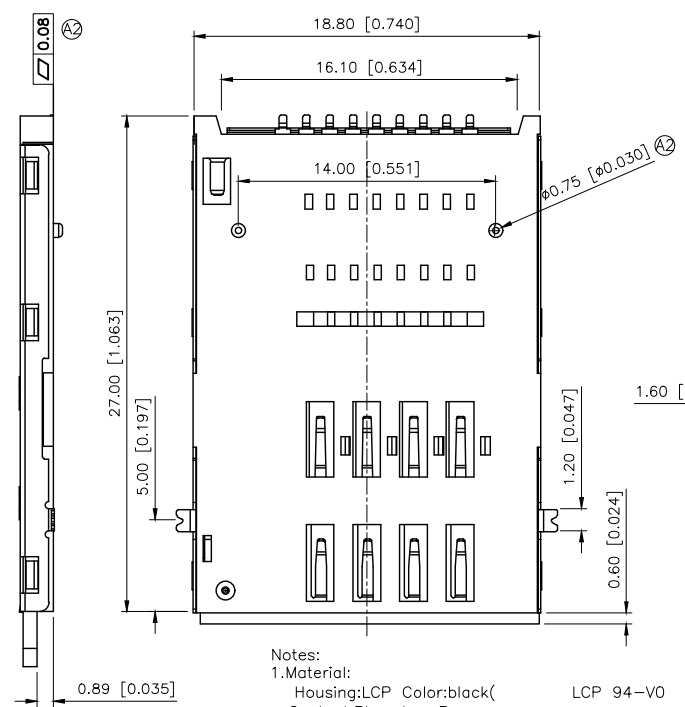
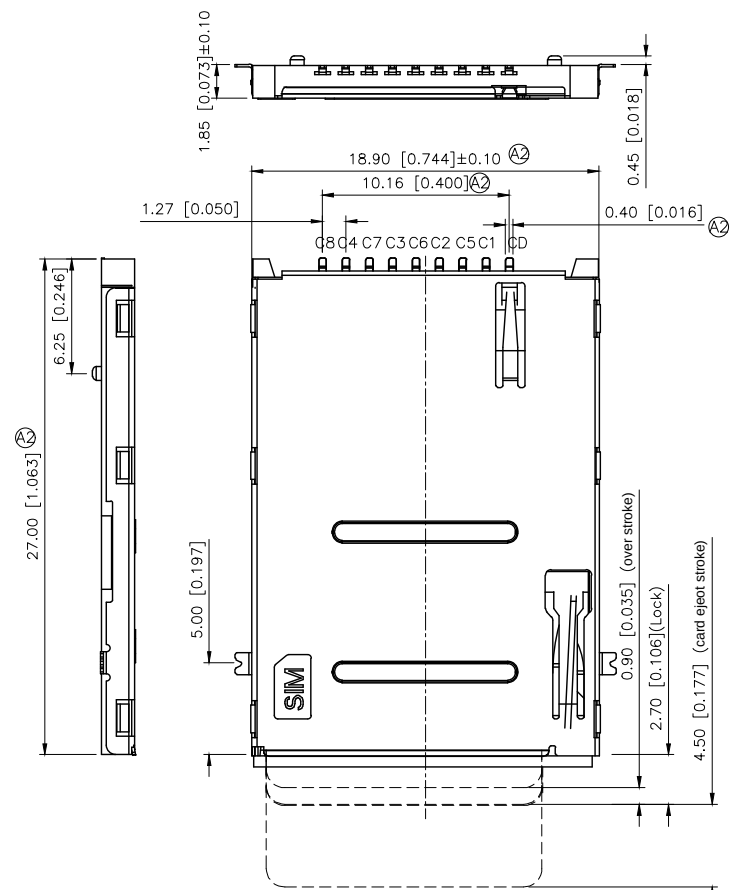


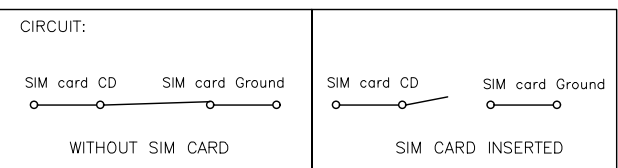
REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A1	N/A			2025.05.15	
A2	ECN-P-2025110806	A2 X9		2025.11.08	



Notes:
1.Material:
Housing:LCP Color:black(LCP 94-V0
Contact:Phosphor Bronze.
SHELL:SUS
2. All NI30u"Min Contact 0.8u",solder area AU 0.8u/min(30u"
0.8u" 0.8u"
3. shell Ni 30" min ,solder gold Flash (30"u,

SPECIFICATION:
3.DURABILITY: 5000 CYCLES MIN(:5000
4.CURRENT:0.5A 0.5Amps)
5.VOLTAGE:40V MAX(40V
6.WITHSTANDING VOLTAGE:500V AC MIN.(UNMATED) 500V AC
7.CONTACT RESISTANCE:30mΩ MAX. 30mΩ
8.INSULATION RESISTANCE:1000MΩ MIN.(UNMATED) 1000
9.OPERATING TEMPERATURE RANGE:-40.C TO +85.C -40 +80
10.ALL THE MATERIAL SHOULD COMPLY WITH THE ROHS ROHS)

SIM pin assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved



AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	VIEW:	MODEL TYPE: SIM CARD CONN
CHECKED	UNIT: mm/in	PART NO.: XKSIM-220
APPROVED	SIZE: A4	DWG NO.:

XKB INDUSTRIAL PRECISION CO.,LIMITED

SCALE	PAGE	REVISION
N/A	1/1	A2